

**Thyristors
logic level**

**BT150S series
BT150M series**

GENERAL DESCRIPTION

Glass passivated, sensitive gate thyristors in a plastic envelope, suitable for surface mounting, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

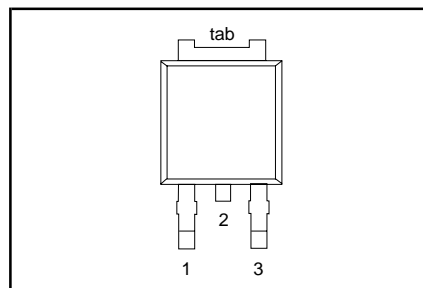
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | MAX. | MAX. | UNIT |
|--------------------------|--|--------------------|--------------------|--------------------|------|
| V_{DRM} , V_{RRM} | BT150S (or BT150M)- Repetitive peak off-state voltages | 500R 500 | 600R 600 | 800R 800 | V |
| $I_{T(AV)}$ | Average on-state current | 2.5 | 2.5 | 2.5 | A |
| $I_{T(RMS)}$ | RMS on-state current | 4 | 4 | 4 | A |
| I_{TSM} | Non-repetitive peak on-state current | 35 | 35 | 35 | A |

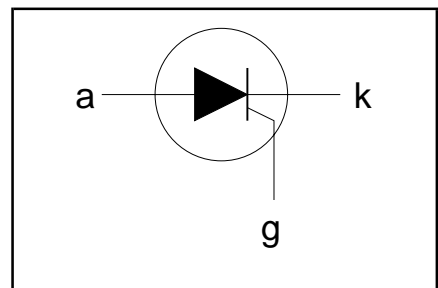
PINNING - SOT428

| PIN NUMBER | Standard S | Alternative M |
|------------|------------|---------------|
| 1 | cathode | gate |
| 2 | anode | anode |
| 3 | gate | cathode |
| tab | anode | anode |

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | | | UNIT |
|-----------------------|--|---|------|---------------------------|---------------------------|--------------|------------------|
| | | | | -500R 500 ¹ | -600R 600 ¹ | -800R 800 | |
| V_{DRM} , V_{RRM} | Repetitive peak off-state voltages | | - | | | | V |
| $I_{T(AV)}$ | Average on-state current | half sine wave; $T_{mb} \leq 111\text{ }^\circ\text{C}$ | - | 2.5 | | | A |
| $I_{T(RMS)}$ | RMS on-state current | all conduction angles | - | 4 | | | A |
| I_{TSM} | Non-repetitive peak on-state current | half sine wave; $T_j = 25\text{ }^\circ\text{C}$ prior to surge $t = 10\text{ ms}$ | - | 35 | | | A |
| I^2t | I^2t for fusing | $t = 8.3\text{ ms}$ | - | 38 | | | A |
| dl_T/dt | Repetitive rate of rise of on-state current after triggering | $t = 10\text{ ms}$ | - | 6.1 | | | A ² s |
| I_{GM} | Peak gate current | $I_{TM} = 10\text{ A}$; $I_G = 50\text{ mA}$; $dl_G/dt = 50\text{ mA}/\mu\text{s}$ | - | 50 | | | A/ μs |
| V_{GM} | Peak gate voltage | | - | 2 | | | A |
| V_{RGM} | Peak reverse gate voltage | | - | 5 | | | V |
| P_{GM} | Peak gate power | | - | 5 | | | W |
| $P_{G(AV)}$ | Average gate power | over any 20 ms period | - | 0.5 | | | W |
| T_{stg} | Storage temperature | | -40 | 150 | | | $^\circ\text{C}$ |
| T_j | Operating junction temperature | | - | 125 ² | | | $^\circ\text{C}$ |

1 Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ μs .

2 Note: Operation above 110 $^\circ\text{C}$ may require the use of a gate to cathode resistor of 1k Ω or less.

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THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------|---|---|------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | pcb (FR4) mounted; footprint as in Fig.14 | - | - | 3.0 | K/W |
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | | - | 75 | - | K/W |

STATIC CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------|---------------------------|---|------|------|------|---------------|
| I_{GT} | Gate trigger current | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$ | - | 15 | 200 | μA |
| I_L | Latching current | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$ | - | 0.17 | 10 | mA |
| I_H | Holding current | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$ | - | 0.10 | 6 | mA |
| V_T | On-state voltage | $I_T = 5\text{ A}$ | - | 1.23 | 1.8 | V |
| V_{GT} | Gate trigger voltage | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$ | - | 0.4 | 1.5 | V |
| I_D, I_R | Off-state leakage current | $V_D = V_{DRM(max)}; I_T = 0.1\text{ A}; T_j = 110\text{ °C}$ | 0.1 | 0.2 | - | V |
| | | $V_D = V_{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125\text{ °C}$ | - | 0.1 | 0.5 | mA |

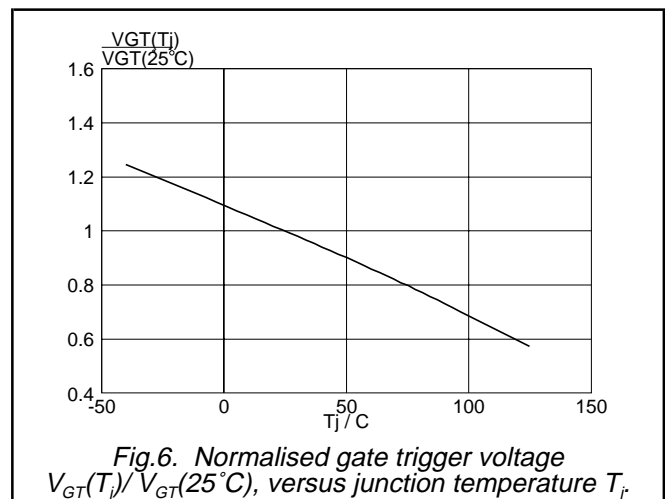
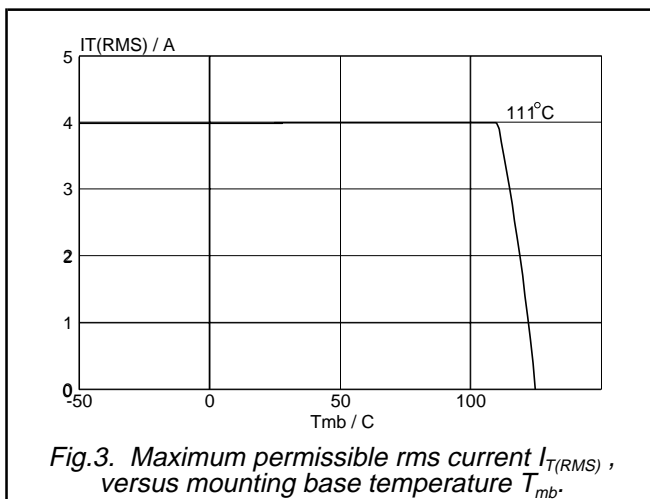
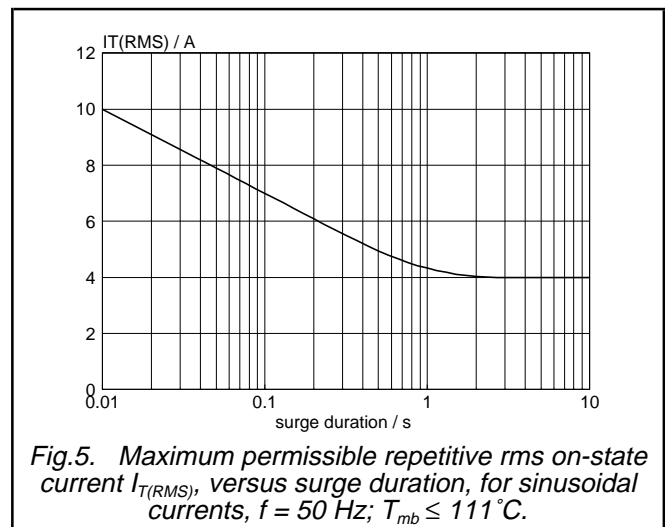
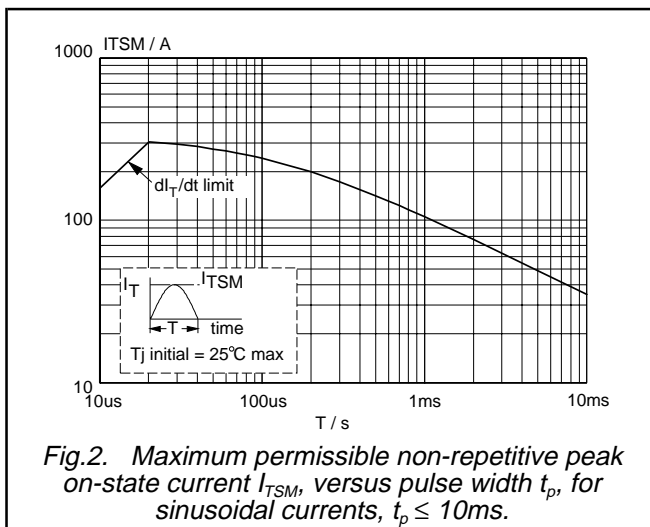
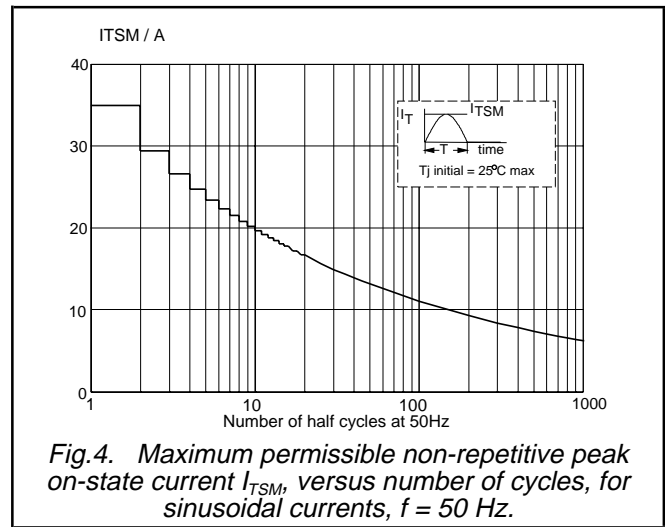
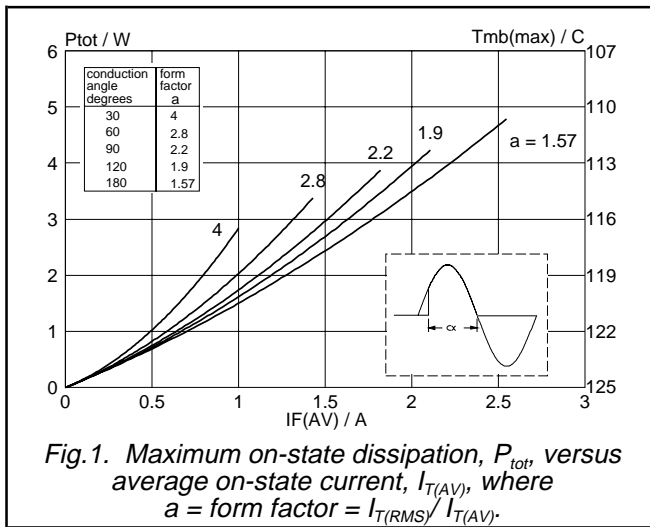
DYNAMIC CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|---|---|------|------|------|------------------|
| dV_D/dt | Critical rate of rise of off-state voltage | $V_{DM} = 67\% V_{DRM(max)}; T_j = 125\text{ °C};$ exponential waveform; $R_{GK} = 100\ \Omega$ | - | 50 | - | V/ μs |
| t_{gt} | Gate controlled turn-on time | $I_{TM} = 10\text{ A}; V_D = V_{DRM(max)}; I_G = 5\text{ mA};$ $dI_G/dt = 0.2\text{ A}/\mu\text{s}$ | - | 2 | - | μs |
| t_q | Circuit commutated turn-off time | $V_D = 67\% V_{DRM(max)}; T_j = 125\text{ °C}; I_{TM} = 8\text{ A};$ $V_R = 10\text{ V}; dI_{TM}/dt = 10\text{ A}/\mu\text{s};$ $dV_D/dt = 2\text{ V}/\mu\text{s}; R_{GK} = 1\text{ k}\Omega$ | - | 100 | - | μs |

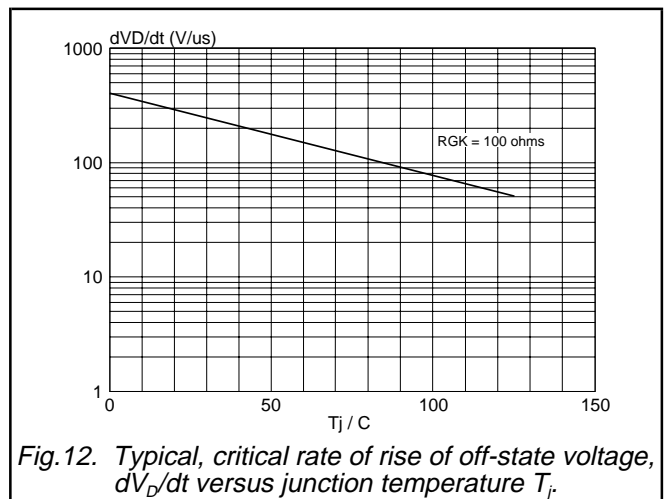
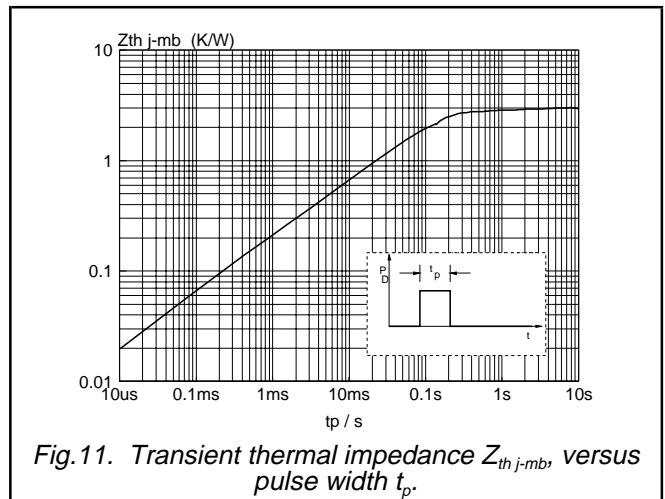
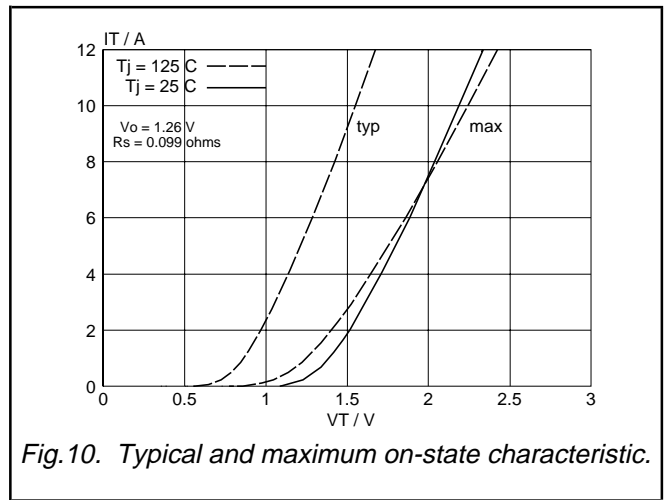
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MECHANICAL DATA

Dimensions in mm

Net Mass: 1.1 g

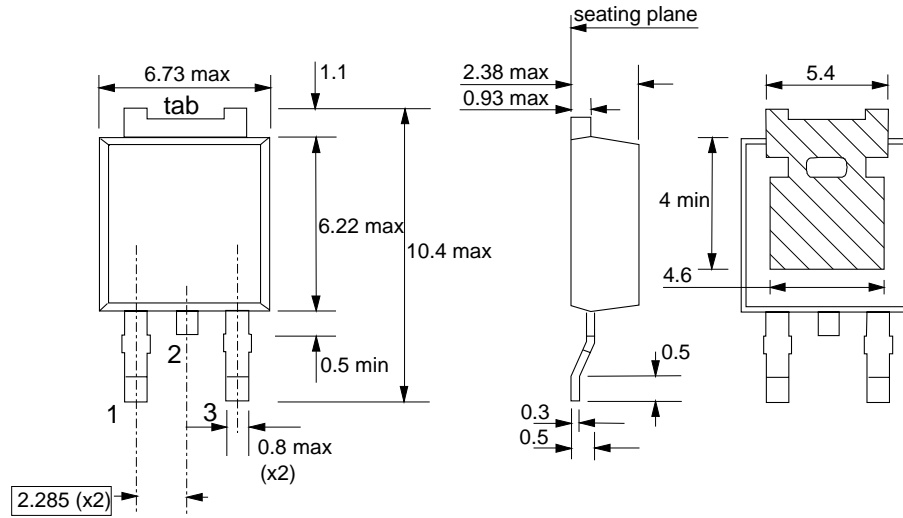


Fig.13. SOT428 : centre pin connected to tab.

MOUNTING INSTRUCTIONS

Dimensions in mm

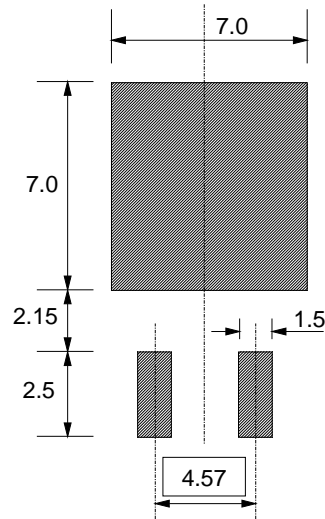


Fig.14. SOT428 : minimum pad sizes for surface mounting.

Notes

- 1. Plastic meets UL94 V0 at 1/8".

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DEFINITIONS

| | |
|--|---|
| Data sheet status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |
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